DIRECT METAL LASER SINTERING

COPPER CuNi2SiCr PRODUCT SPECIFICATIONS

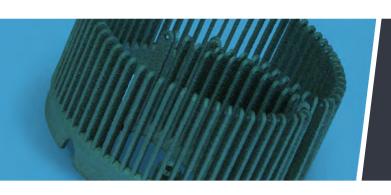


PRODUCT DESCRIPTION

Copper CuNi2SiCr is an alloyed copper material, which combines good mechanical properties with high thermal and electrical conductivity. This alloy can be used in rough environments where pure copper is not feasible.

APPLICATIONS

Copper CuNi2SiCr is an excellent choice when high thermal and/or electrical conductivity is needed.



KEY PRODUCT BENEFITS

- Good mechanical properties
- High thermal conductivity
- High electrical conductivity

CHEMICAL COMPOSITION

According 2.0855; CW111C; C18000

Cu (balance)

Si (0.50 - 0.80 wt-%)

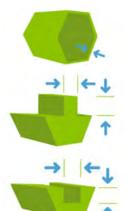
Mn (≤0.1 wt-%)

Cr (0.20 - 0.50 wt-%)

Ni (2.00 - 3.00 wt-%)

Fe (≤0.15 wt-%) Pb (≤0.02 wt-%)

GEOMETRICAL LIMITS



Min. wall thickness 1.00mm - Min. feature size 1.00mm

Min. embossed details 0.5mm high and wide and 0.8mm for legible text and images

Min. engraved details 0.5mm deep and 0.6mm wide; 1.0mm wide for legible text and images

PROPERTIES

Heat Treatment	Tensile Strength	Yield Strength 0.2%	Elongation %	Hardness	Density
N/A	35 ksi +/- 2 ksi	28 ksi +/- 2 ksi	50%	HRB 77	> 99.5%
Precipitation Hardening	69 ksi +/- 4 ksi	58 ksi +/- 4 ksi	25%	HRB 85	> 99.5%
	As Built		Precipitation Hardening		

	As Built	Precipitation Hardening		
Thermal Conductivity	90 W/mK	165 W/mK		
Electrical Conductivity	8 MS/m	15 MS/m		

RESOLUTION

	Layer Thickness	Build Envelope	Min. Feature Size
High Resolution	0.02mm	100 x 100 x 100mm	1.00mm

SURFACE

	0°	45° bottom	45° top	90°
High Resolution	Ra 340 µin	Ra 490 μin	Ra 280 µin	Ra 230 µin



High Resolution 20 µin

STANDARD TOLERANCES:

Typically, for well-designed parts, with a designated build direction, tolerances of \pm 0.1mm to \pm 0.2mm + 0.005mm/mm are expected and achieved. Certain geometries may cause distortions due to internal stress which may lead to higher deviations.